Atty. Dkt. No.: 2557-000158/US

DECLARATION

As a below named inventor, I hereby declare that:

My residence, mailing address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

which is claimed and	for which a patent is s	oug	nt on the inventior	n en	titled:	
SEMICONDUCTOR	TEST SYSTEM AND	ME	THOD OF OPERA	ATIN	IG THE	SAME
the specification of wh	nich (check one)					
o w A	attached hereto. r ras filed on as r pplication No. pplicable).					
l hereby state that l ha specification, includinલ						
I acknowledge the dudefined in 37 CFR § information which becathe national or PCT in I hereby claim foreign foreign application(s) international application States of America, list any foreign application application having a claimed:	1.56, including for ame available betwee ternational filing date priority benefits unde for patent or inverson which designated at the for patent or inventor fo	conting the of t	nuation-in-part aper filing date of the per continuation-in- U.S.C. §§ 119(a)-certificate, or 3 ast one country of dentified below, be certificate, or an	oplicoprion part -(d) 865(a ther by ch	eations, recapilicated applicated	materia tion and tion.) of any ny PCT e United the box nationa
	PRIOR FOREIGN	APPI				
APPN. SERIAL NO.	COUNTRY		DATE FILED (MM/DD/YYYY)	}	PRIORITY Yes	Y CLAIM No
2002-81740	Korea	-	12/20/2002		\boxtimes	
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I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below:

PRIOR PROVISIONAL APPLICATION(S)			
APPN. SERIAL NO.	DATE FILED (MM/DD/YYYY)		

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s) listed below:

PRIOR U.S. APPLICATION(S)				
APPN. SERIAL NO.	DATE FILED (MM/DD/YYYY)	STATUS - PATENTED, PENDING, ABANDONED		
·				

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY

I hereby appoint the following attorneys with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

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